

# **BCR8KM-20LA**

# Triac

Medium Power Use

REJ03G0337-0100 Rev.1.00 Aug.20.2004

#### **Features**

I<sub>T (RMS)</sub>: 8 A
 V<sub>DRM</sub>: 1000 V

•  $I_{FGTI}$ ,  $I_{RGTI}$ ,  $I_{RGTIII}$ : 30 mA

Viso: 2000 V

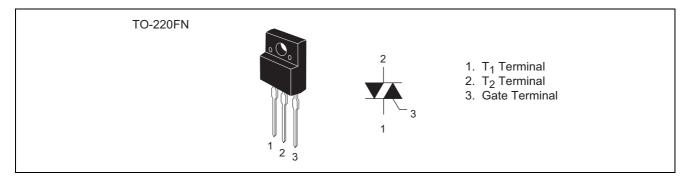
Insulated Type

• Planar Passivation Type

• UL Recognized: Yellow Card No. E223904

File No. E80271

#### **Outline**



## **Applications**

Switching mode power supply, washing machine, motor control, heater control, and other general controlling devices

## **Maximum Ratings**

Parameter	Symbol	Voltage class	Unit	
Farameter	Symbol	20	Offic	
Repetitive peak off-state voltage <sup>Note1</sup>	$V_{DRM}$	1000	V	
Non-repetitive peak off-state voltage <sup>Note1</sup>	$V_{DSM}$	1200	V	

#### BCR8KM-20LA

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I <sub>T (RMS)</sub>	8	А	Commercial frequency, sine full wave 360° conduction, Tc = 89°C
Surge on-state current	I <sub>TSM</sub>	80	А	60Hz sinewave 1 full cycle, peak value, non-repetitive
I <sup>2</sup> t for fusing	l <sup>2</sup> t	26	A <sup>2</sup> s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	$P_{GM}$	5	W	
Average gate power dissipation	P <sub>G (AV)</sub>	0.5	W	
Peak gate voltage	$V_{GM}$	10	V	
Peak gate current	$I_{GM}$	2	Α	
Junction temperature	Tj	- 40 to +125	°C	
Storage temperature	Tstg	- 40 to +125	°C	
Mass	_	2.0	g	Typical value
Isolation voltage	Viso	2000	V	Ta = 25°C, AC 1 minute, $T_1 \cdot T_2 \cdot G$ terminal to case

Notes: 1. Gate open.

# **Electrical Characteristics**

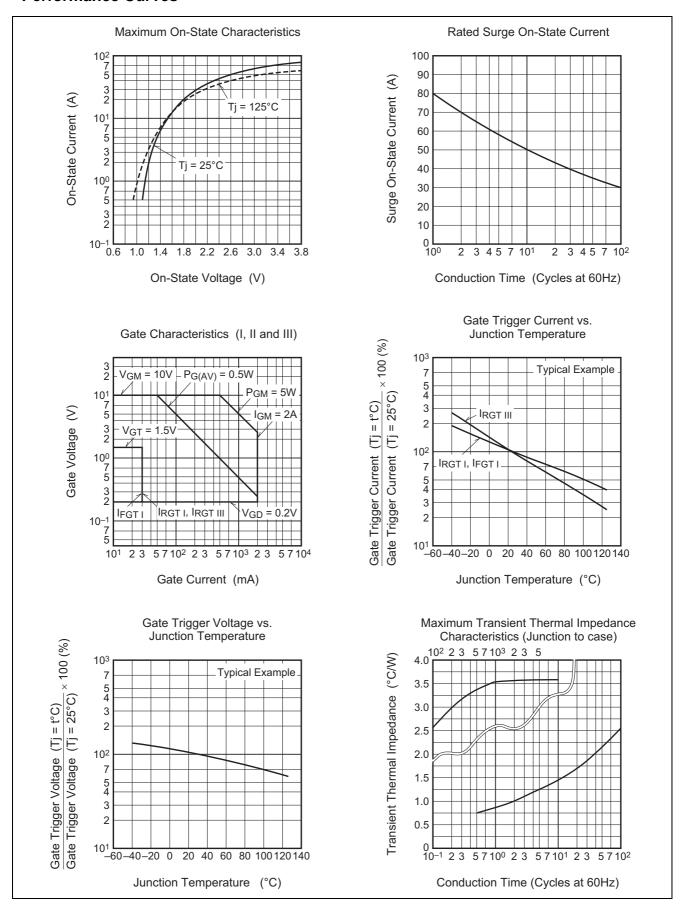
Parameter		Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak off-state current		I <sub>DRM</sub>	_	_	2.0	mA	Tj = 125°C, V <sub>DRM</sub> applied
On-state voltage		$V_{TM}$	_	_	1.6	V	Tc = 25°C, I <sub>TM</sub> = 12 A, Instantaneous measurement
Gate trigger voltage <sup>Note2</sup>	I	$V_{FGTI}$	_	_	1.5	V	$Tj = 25$ °C, $V_D = 6$ V, $R_L = 6$ Ω,
	II	$V_{RGTI}$	_	_	1.5	V	$R_G = 330 \Omega$
	III	$V_{RGTIII}$	_	_	1.5	V	
Gate trigger current <sup>Note2</sup>	rent <sup>Note2</sup> I		_	_	30	mA	$Tj = 25$ °C, $V_D = 6$ V, $R_L = 6$ Ω,
	II	$I_{RGTI}$	_	_	30	mA	$R_G = 330 \Omega$
	III	I <sub>RGTIII</sub>	_	_	30	mA	
Gate non-trigger voltage		$V_{GD}$	0.2	_	_	V	$Tj = 125$ °C, $V_D = 1/2 V_{DRM}$
Thermal resistance		R <sub>th (j-c)</sub>	_	_	3.6	°C/W	Junction to case <sup>Note3</sup>
Critical-rate of rise of off-state commutating voltage Note4		(dv/dt)c	10	_	_	V/μs	Tj = 125°C

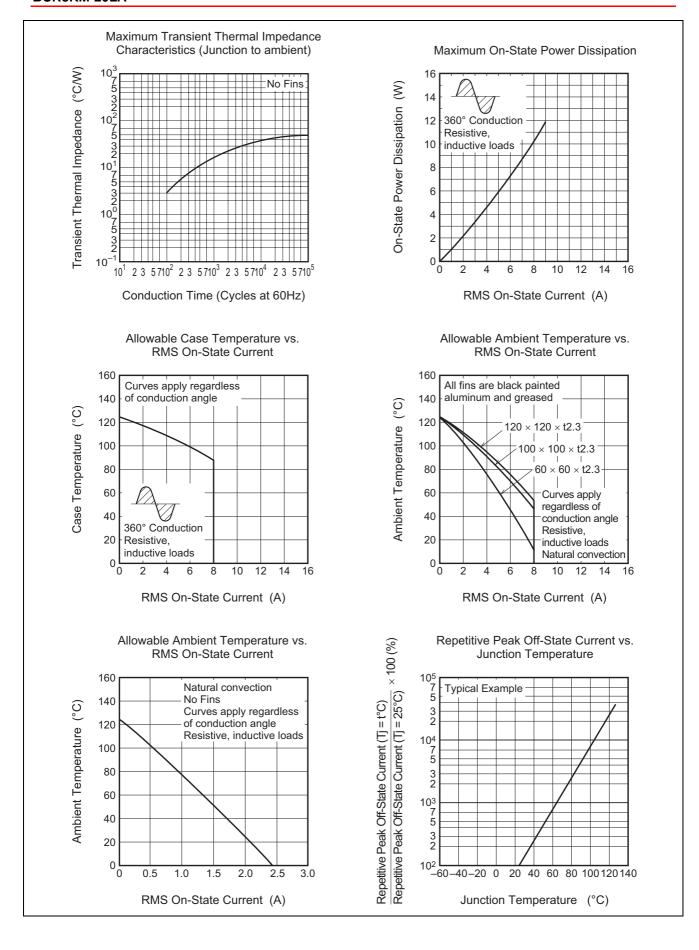
Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

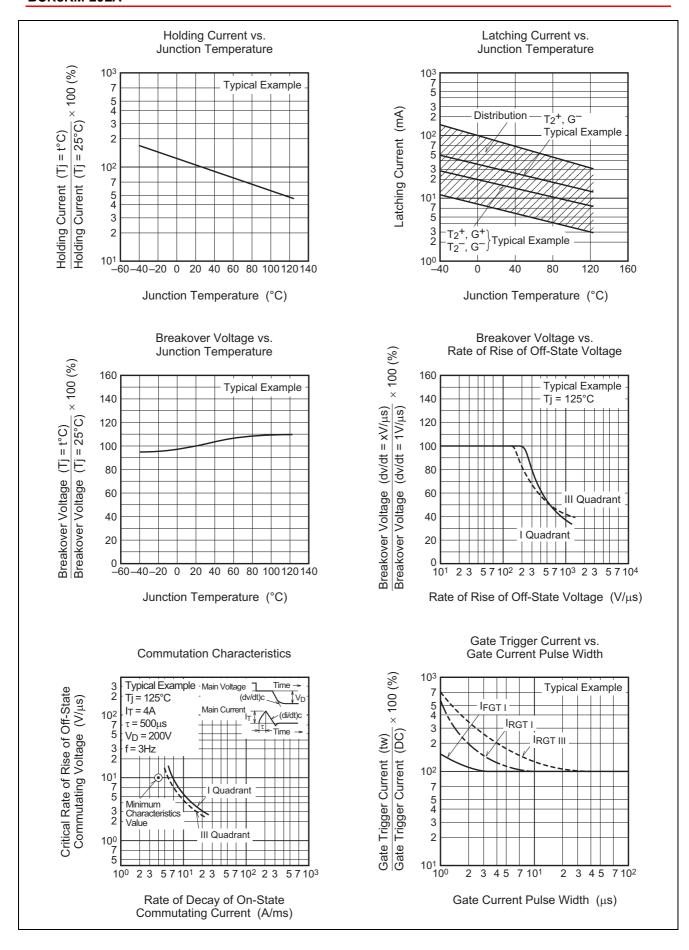
- 3. The contact thermal resistance  $R_{th\;(c\text{-}f)}$  in case of greasing is 0.5°C/W.
- 4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

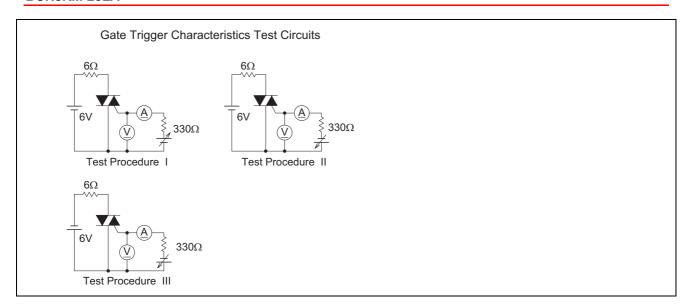
Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature Tj = 125°C	Supply Voltage  → Time
2. Rate of decay of on-state commutating current (di/dt)c = - 4 A/ms	Main Current — (di/dt)c — Time
3. Peak off-state voltage V <sub>D</sub> = 400 V	Main Voltage Time (dv/dt)c

#### **Performance Curves**

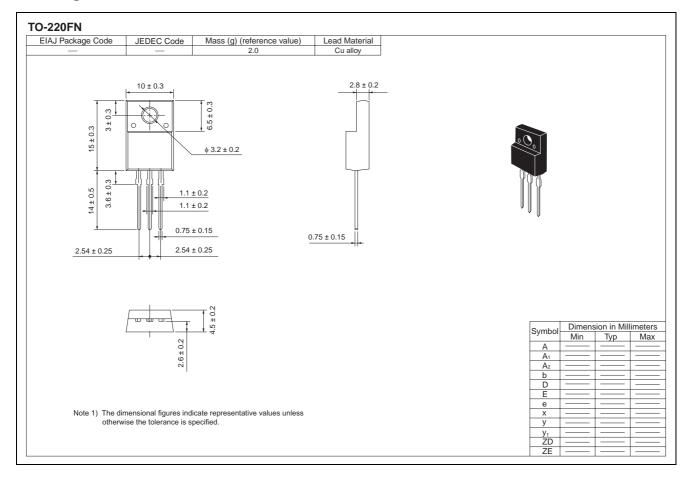








# **Package Dimensions**



## **Order Code**

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name	BCR8KM-20LA
Lead form	Plastic Magazine (Tube)	50	Type name – Lead forming code	BCR8KM-20LA-A8

Note: Please confirm the specification about the shipping in detail.

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